1 Characteristics

Table 2: Absolute ratings (limiting values, per diode, at 25 °C, unless otherwise specified)

Symbol	Paramete	Value	Unit		
Vrrm	Repetitive peak reverse voltage			45	V
I _{F(RMS)}	Forward rms current			30	Α
	Average forward current	T 155 %C	Per diode	15	A
IF(AV)	δ = 0.5, square wave	$1_{\rm C} = 155^{\circ}{\rm C}$	Per device	30	
IFSM	Surge non repetitive forward currenttp = 10 ms sinusoidal			220	А
Parm ⁽¹⁾	$ \begin{array}{ll} \mbox{Repetitive peak avalanche power} & t_{p} = 10 \ \mbox{\mu s}, \\ \mbox{T}_{j} = 125 \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \$			430	W
T _{stg}	Storage temperature range			-65 to +175	
Tj	Maximum operating junction temperat	175	ംറ		
	Maximum operating junction temperat without reverse bias, t = 1 hour for D ² F	200			

Notes:

⁽¹⁾For pulse time duration deratings, please refer to Figure 3. More details regarding the avalanche energy measurements and diode validation in the avalanche are provided in the STMicroelectronics Application notes AN1768, "Admissible avalanche power of Schottky diodes" and AN2025, "Converter improvement using Schottky rectifier avalanche specification".

 $^{(2)}(dP_{tot}/dT_j) < (1/R_{th(j-a)})$ condition to avoid thermal runaway for a diode on its own heatsink.

Symbol	Parameter				Unit
R _{th(j-c)}			Per diode	1.60	
	lunction to copp	TO-220AB / D-PAK	Total	0.95	
	T	TO 247	Per diode	1.5	°C/W
		10-247	Total	0.9	
R _{th(c)}	Coupling	TO-220AB / D2PAK/ TO-247		0.3	

Table 3: Thermal parameters

When the diodes 1 and 2 are used simultaneously:

 $\Delta T_{j \text{ (diode1)}} = P_{\text{(diode1)}} x R_{\text{th(j-c)}} \text{ (per diode)} + P_{\text{(diode2)}} x R_{\text{th(c)}}$



Characteristics

Table 4: Static electrical characteristics (per diode)							
Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
IR ⁽¹⁾	Reverse leakage current	Tj = 25 °C	Vr = Vrrm	-		200	μA
		Tj = 125 °C		-	11	40	mA
VF ⁽¹⁾	Forward voltage drop	Tj = 125 °C	I _F = 15 A	-	0.5	0.57	
		Tj = 25 °C	1 00 4	-		0.84	V
		T _j = 125 °C	$I_F = 30 A$	-	0.65	0.72	

Table 4: Static electrical characteristics (per diode)

Notes:

 $^{(1)}\text{Pulse test:}$ tp = 380 µs, δ < 2%

To evaluate the conduction losses use the following equation:

 $P = 0.42 \text{ x } I_{F(AV)} + 0.01 \text{ x } I_{F}^{2}(RMS)$









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Characteristics





2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

- Cooling method: by conduction (C)
- Epoxy meets UL 94,V0
- Recommended torque value: 0.55 N·m (for TO-220AB and TO-247)
- Maximum torque value: 0.7 N·m (for TO-220AB)
- Maximum torque value: 1.0 N·m (for TO-247)

2.1 TO-220AB package information







Package information

Table 5: TO-220AB package mechanical data						
	Dimensions					
Ref.	Millim	neters	Inc	hes		
	Min.	Max.	Min.	Max.		
А	4.40	4.60	0.173	0.181		
b	0.61	0.88	0.024	0.035		
b1	1.14	1.55	0.045	0.061		
С	0.48	0.70	0.019	0.028		
D	15.25	15.75	0.600	0.620		
D1	1.27	typ.	0.050 typ.			
E	10.00	10.40	0.394	0.409		
е	2.40	2.70	0.094	0.106		
e1	4.95	5.15	0.195	0.203		
F	1.23	1.32	0.048	0.052		
H1	6.20	6.60	0.244	0.260		
J1	2.40	2.72	0.094	0.107		
L	13.00	14.00	0.512	0.551		
L1	3.50	3.93	0.138	0.155		
L20	16.40 typ.		0.646 typ.			
L30	28.90 typ.		1.138 typ.			
ØP	3.75	3.85	0.148	0.152		
Q	2.65	2.95	0.104	0.116		









Table 6: TO-247 package mechanical data

Package information

	Dimensions							
Ref.	Millimeters			Inches				
	Min.	Тур.	Max.	Min.	Тур.	Max.		
А	4.85		5.15	0.191		0.203		
A1	2.20		2.60	0.086		0.102		
b	1.00		1.40	0.039		0.055		
b1	2.00		2.40	0.078		0.094		
b2	3.00		3.40	0.118		0.133		
С	0.40		0.80	0.015		0.031		
D ⁽¹⁾	19.85		20.15	0.781		0.793		
E	15.45		15.75	0.608		0.620		
е	5.30	5.45	5.60	0.209	0.215	0.220		
L	14.20		14.80	0.559		0.582		
L1	3.70		4.30	0.145		0.169		
L2		18.50			0.728			
ØP ⁽²⁾	3.55		3.65	0.139		0.143		
ØR	4.50		5.50	0.177		0.217		
S	5.30	5.50	5.70	0.209	0.216	0.224		

Notes:

⁽¹⁾Dimension D plus gate protusion does not exceed 20.5 mm

 $^{\rm (2)} {\rm Resin}$ thickness around the mounting hole is not less than 0.9 mm.



2.3 D²PAK package information





This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.



Package information

Table 7: D ² PAK package mechanical data					
		Dimer	nsions		
Ref.	Millim	neters	Inc	hes	
	Min.	Max.	Min.	Max.	
А	4.36	4.60	0.172	0.181	
A1	0.00	0.25	0.000	0.010	
b	0.70	0.93	0.028	0.037	
b2	1.14	1.70	0.045	0.067	
с	0.38	0.69	0.015	0.027	
c2	1.19	1.36	0.047	0.053	
D	8.60	9.35	0.339	0.368	
D1	6.90	8.00	0.272	0.311	
D2	1.10	1.50	0.043	0.060	
E	10.00	10.55	0.394	0.415	
E1	8.10	8.90	0.319	0.346	
E2	6.85	7.25	0.266	0.282	
е	2.54	typ.	0.100		
e1	4.88	5.28	0.190	0.205	
н	15.00	15.85	0.591	0.624	
J1	2.49	2.90	0.097	0.112	
L	1.90	2.79	0.075	0.110	
L1	1.27	1.65	0.049	0.065	
L2	1.30	1.78	0.050	0.070	
R	0.4	typ.	0.0)15	
V2	0°	8°	0°	8°	



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3 Ordering information

Table 8: Ordering information					
Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPS3045CT	STPS3045CT	TO-220AB	1.9 g	50	Tube
STPS3045CG	STPS3045CG	PS3045CG		50	Tube
STPS3045CG-TR	STPS3045CG	D-PAK	1.36 g	1000	Tape and reel
STPS3045CW	STPS3045CW	TO-247	4.46 g	30	Tube

4 Revision history

Table 9: Document revision history

Date	Revision	Changes
Jul-2003	6E	Last update.
06-Nov-2012	7	Removed SOT-93 and TOP-3I packages. Table 2: Operating range (T_i) extension from -40 to +175° C, $I_{F(AV)}$ per diode updated to 15 A. Updated "Total" values in Table 3. Updated tables in Section 2: Package information.
04-Apr-2013	8	Added value for maximum T_j in forward mode. Updated Table 9.
02-Aug-2016	9	Updated D ² PAK package information. Removed I ² PAK and TO-220FPAB package information.



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